



# SSCT4V511D2

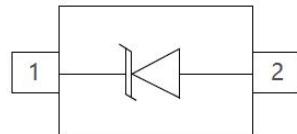
## SSCT4V511D2

1-Line Uni-directional TVS Diode

### ● Description

The SSCT4V511D2 is an uni-directional TVS diode, utilizing leading monolithic silicon technology to provide fast response time and low ESD clamping voltage, making this device an ideal solution for protecting voltage sensitive data and power line. The SSCT4V511D2 complies with the IEC 61000-4-2 (ESD) with  $\pm 30\text{kV}$  air and  $\pm 30\text{kV}$  contact discharge. The small size and high ESD surge protection make SSCT4V511D2 an ideal choice to protect cell phone, digital cameras, audio players and many other portable applications.

### ● PIN configuration



Top view



Marking

### ● Features

- ◊ 2550W Peak Pulse Power per Line ( $t_p=8/20\mu\text{s}$ )
- ◊ Protects one date or power line
- ◊ Working voltage: 4.5V
- ◊ 2-pin leadless package
- ◊ Complies with following standards:
  - IEC61000-4-2(ESD)  $\pm 30\text{Kv}(\text{contact}), \pm 30\text{kV}(\text{air})$
  - IEC61000-4-4(EFT) 40A(5/50ns)
  - IEC61000-4-5(Lightning) 170A(8/20 $\mu\text{s}$ )
- ◊ RoHS Compliant

### ● Applications

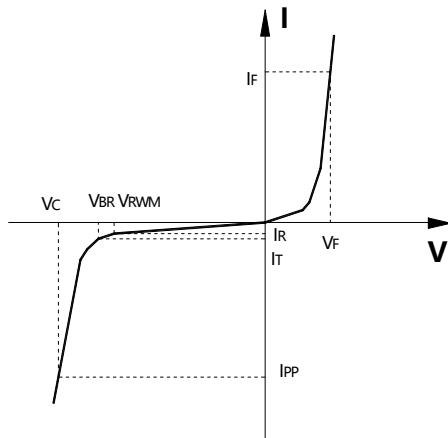
- ◊ Mobile Phones
- ◊ Battery Protection
- ◊ Power Line Protection
- ◊ Vbat pin for Mobile Devices
- ◊ Hand Held Portable Applications

### ● Mechanical Characteristics

- ◊ Package: SOD-323
- ◊ Case Material: "Green" Molding Compound.
- ◊ UL Flammability Classification Rating 94V-0
- ◊ Moisture Sensitivity: Level 3 per J-STD-020
- ◊ Terminal Connections: See Diagram Below
- ◊ Marking Information: See Below

- Electronic Parameter

Symbol	Parameter
V <sub>RWM</sub>	Peak Reverse Working Voltage
I <sub>R</sub>	Reverse Leakage Current @ V <sub>RWM</sub>
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>
I <sub>T</sub>	Test Current
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current
V <sub>C</sub>	Clamping Voltage @ I <sub>PP</sub>
P <sub>PPP</sub>	Peak Pulse Power
C	Junction Capacitance



- Absolute maximum rating @TA=25°C

Symbol	Parameter	Value	Units
V <sub>ESD</sub>	ESD Rating per IEC61000-4-2:Contact Air	±30 ±30	KV
P <sub>PPP</sub>	Peak Pulse Power (8/20μs)	2550	W
I <sub>PP</sub>	Peak Pulse Current (8/20 μ s)	170	A
T <sub>STG</sub>	Storage Temperature	-55/+150	°C
T <sub>J</sub>	Operating Temperature	-55/+125	°C

- Electrical Characteristics @TA=25°C

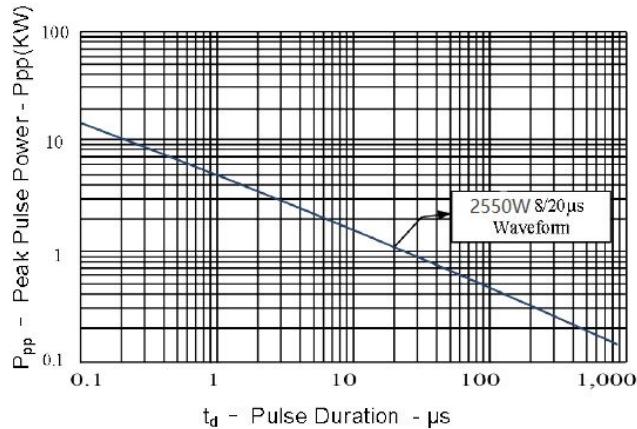
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Peak Reverse Working Voltage	V <sub>RWM</sub>	Any I/O to Ground		4.5		V
Breakdown Voltage	V <sub>BR</sub>	IT = 1mA	4.8			V
Reverse Leakage Current	I <sub>R</sub>	VRWM = 4.5V			0.2	μA
Forward Voltage	V <sub>F</sub>	If=10mA	0.6		1.0	V
Clamping Voltage	V <sub>C1</sub>	IPP=1A, tP = 8/20μs			8.5	V
Clamping Voltage	V <sub>C2</sub>	IPP=170A, tP = 8/20μs			15	V
Dynamic Resistance <sup>1,2</sup>	R <sub>DYN</sub>	TLP=0.2/100ns		0.05		Ω
Junction Capacitance	C <sub>J</sub>	VR = 0V, f = 1MHz,	450		600	pF

Note: 1、TLP Setting: tp=100ns, tr=0.2ns, ItLP and VTLP sample window:t1=70ns to t2=90ns.

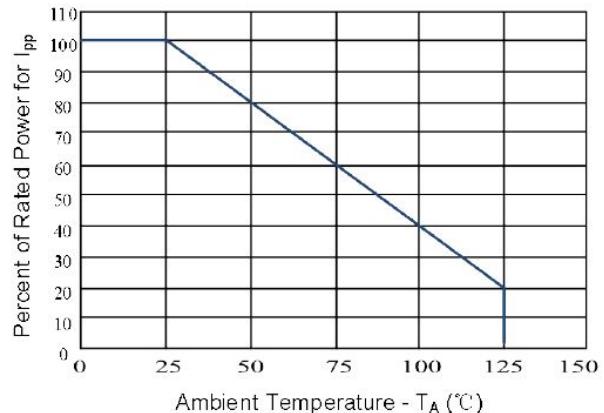
2、Dynamic resistance calculated from IPP=4A to IPP=16A using “Best Fit”

- Typical Performance Characteristics( $T_A=25^\circ\text{C}$  unless otherwise Specified)

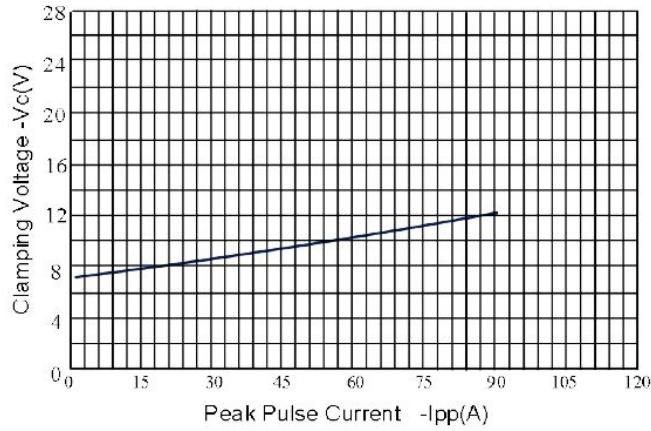
**Figure 1: Peak Pulse Power vs. Pulse Time**



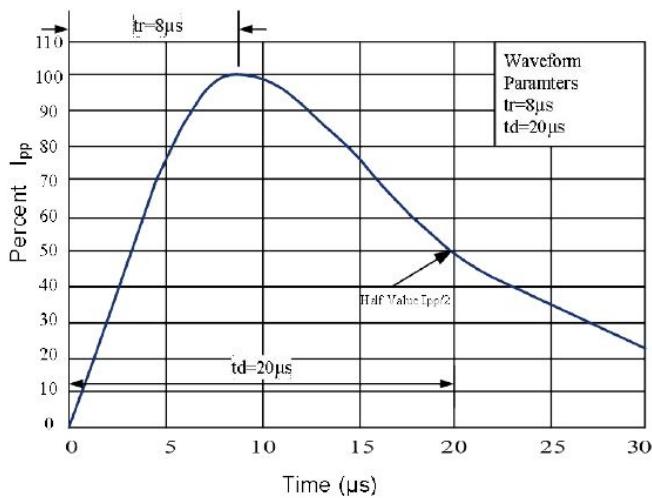
**Figure 2: Power Derating Curve**



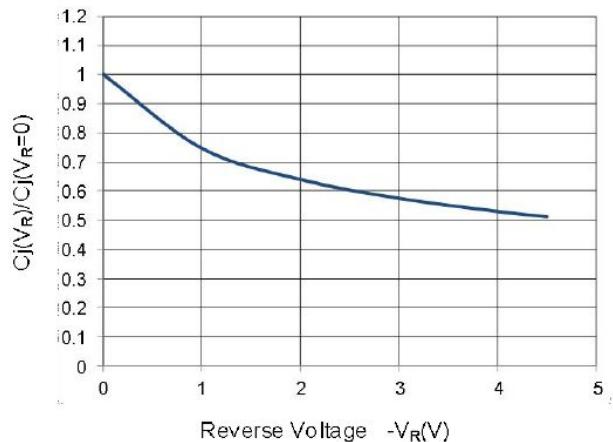
**Figure 3: Clamping Voltage vs. Peak Pulse Current**



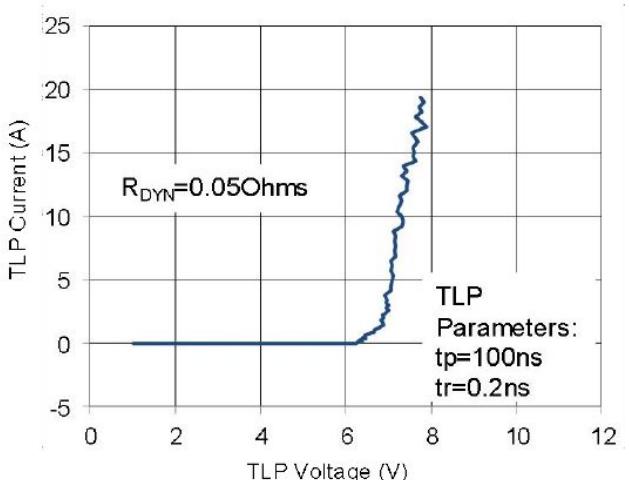
**Figure 5: 8/20μs Pulse Waveform**



**Figure 4: Normalized Junction Capacitance vs. Reverse Voltage**



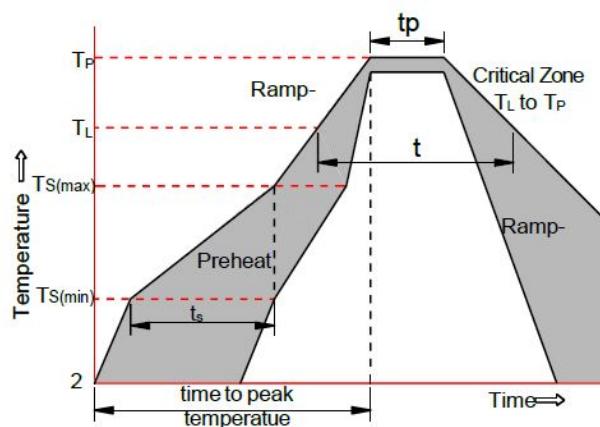
**Figure 6: TLP Curve**



- Soldering Parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min (Ts(min))	+150°C
	-Temperature Max(Ts(max))	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp ( $T_L$ ) to peak)		3°C/sec. Max
Ts(max) to $T_p$ - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature( $T_L$ )(Liquid us)	+217°C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp ( $T_p$ )		8 min. Max
Do not exceed		+260°C

**FIG. : Reflow condition**





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## ● Package Information

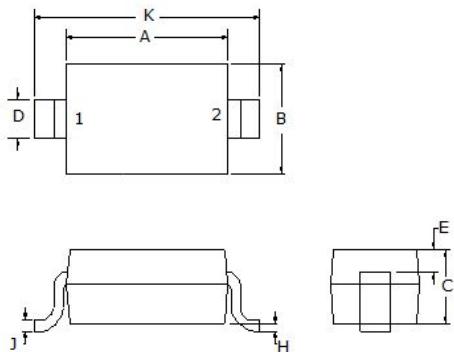
### Ordering Information

Device	Package	Qty per Reel	Reel Size
SSCT4V511D2	SOD-323	3000	7 Inch

### Mechanical Data

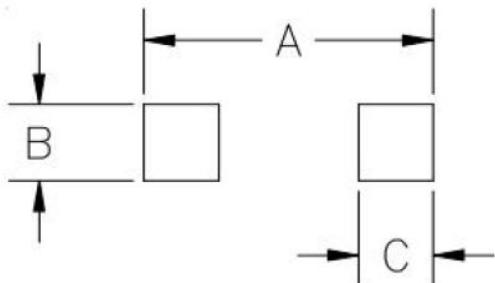
Case: SOD-323

Case Material: Molded Plastic. UL Flammability



Dim	Dimensions			
	Millimeters		Inches	
	Min	Max	Min	Max
A	1.50	1.80	0.060	0.071
B	1.2	1.40	0.045	0.054
C	-	1.10	-	0.043
D	0.30	0.40	0.012	0.016
H	-	0.10	-	0.004
J	0.10	0.25	0.004	0.010
K	2.30	2.70	0.090	0.107

### Suggested Land Pattern



Dim	Dimensions	
	Millimeters	Inches
A	3.15	0.120
B	0.80	0.031
C	0.80	0.031



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